

Electronic Patent Application Fee Transmittal

Application Number:	10788700			
Filing Date:	27-Feb-2004			
Title of Invention:	Full-wafer or large area imprinting with multiple separated sub-fields for high throughput lithography			
First Named Inventor/Applicant Name:	Sidgata V. Sreenivasan			
Filer:	Kelly K. Kordzik/Danielle Chandler			
Attorney Docket Number:	P107/MII-72-54-03			
Filed as Small Entity				
Utility Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Claims in excess of 20	2202	3	25	75
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Extension-of-Time:				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Total in USD (\$)				75